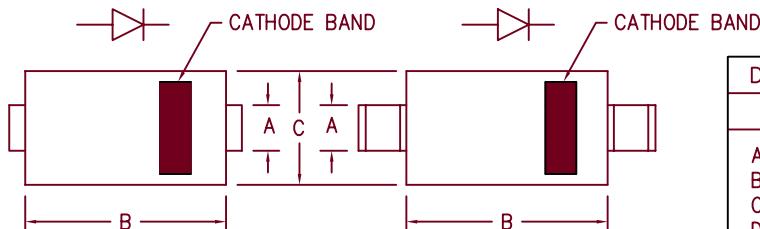


5 Amp Schottky Rectifier

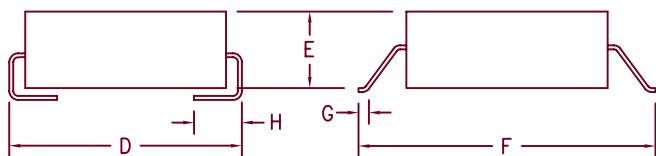
HSM550, HSM560



D0214AB

D0215AB

Dim.	Inches		Millimeter		Notes
	Minimum	Maximum	Minimum	Maximum	
A	.117	.123	2.97	3.12	
B	.260	.280	6.60	7.11	
C	.220	.245	5.59	6.22	
D	.307	.322	7.80	8.18	
E	.075	.095	1.91	2.41	
F	.380	.400	9.65	10.16	
G	.025	.040	.640	1.02	
H	.030	.060	.760	1.52	



Microsemi
Catalog Number

Industry
Part Number

Working
Peak Reverse
Voltage

Repetitive
Peak Reverse
Voltage

HSM550*
HSM560*

SK55L, B550C
SK56L, B560C

50V

50V

60V

60V

* Add Suffix J for J Lead or G for Gull Wing Lead Configuration

- Schottky Barrier Rectifier
- Guard Ring Protection
- High Current Capability
- 175°C Junction Temperature
- Surface mount packages

Electrical Characteristics

Average forward current
Maximum surge current
Max peak forward voltage
Max peak forward voltage
Max peak reverse current
Typical junction capacitance

I F(AV) 5.0 Amps
I FSM 250 Amps
V FM .52 Volts
V FM .65 Volts
I RM 250 μ A
CJ 355 pF

Square wave
8.3ms, half sine, TJ = 175°C
IFM = 1.0A; TJ = 25°C *
IFM = 5.0A; TJ = 25°C *
VRM, TJ = 25°C
VR = 5.0V, TJ = 25°C

*Pulse test: Pulse width 300 μ sec, Duty cycle 2%

Thermal and Mechanical Characteristics

Storage temperature range
Operating junction temp range
Maximum thermal resistance
Weight

T_{STG}
T_J
R_{θJL}

-55°C to 175°C
-55°C to 175°C
22°C/W Junction to lead
.008 ounces (.22 grams) typical

HSM550, HSM560

Figure 1
Typical Forward Characteristics

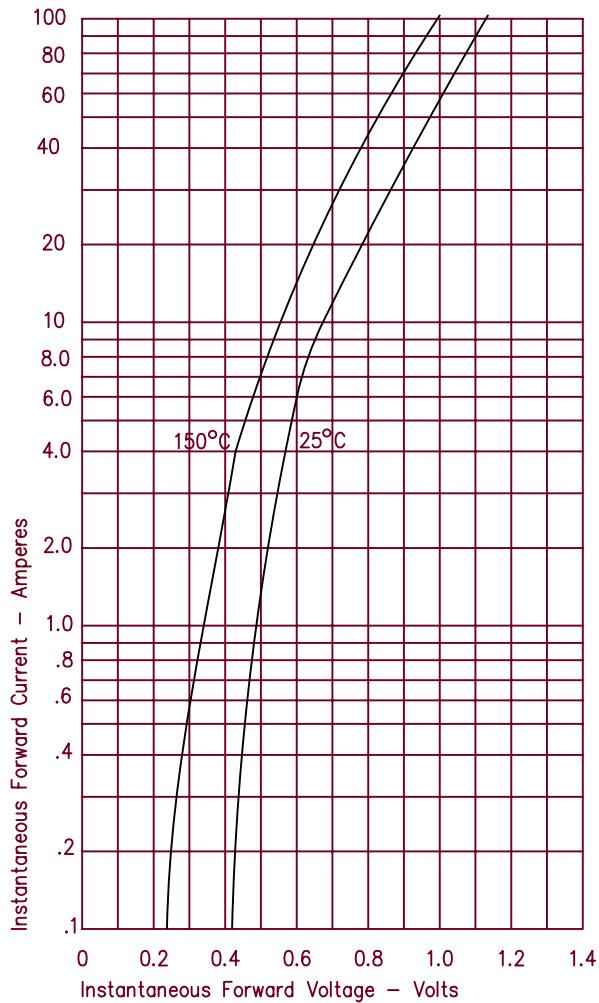


Figure 3
Typical Junction Capacitance

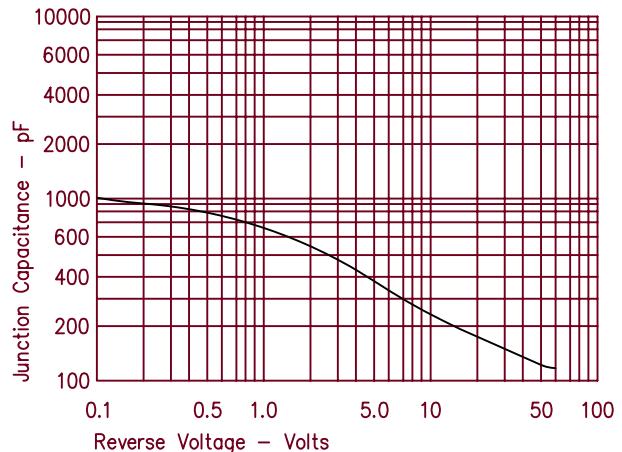
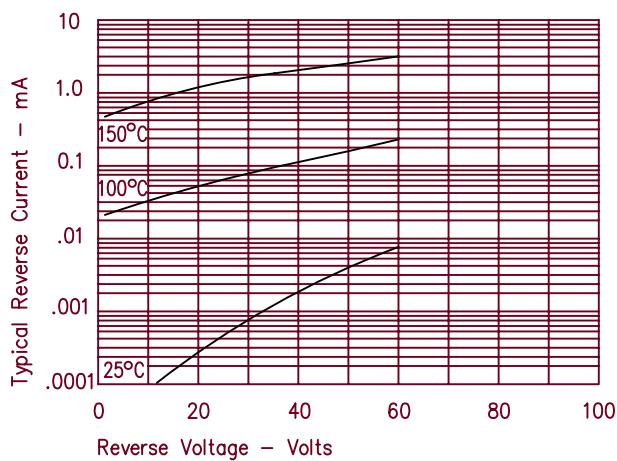


Figure 2
Typical Reverse Characteristics



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